

General Description

The TS2940 series of fixed-voltage monolithic micro-power voltage regulators is designed for a wide range of applications. This device excellent choice of use in battery-power application. Furthermore, the quiescent current increases on slightly at dropout, which prolongs battery life.

This series of fixed-voltage regulators features very low ground current (100uA Typ.) and very low drop output voltage (Typ. 60mV at light load and 600mV at 1A). This includes a tight initial tolerance of 1% typ., extremely good line regulation of 0.05% typ., and very low output temperature coefficient.

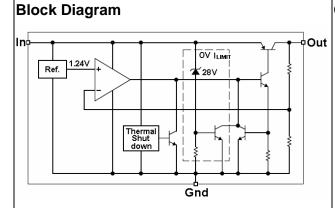
This series is offered in 3-pin TO-263, TO-220, TO-252 & SOT-223 package.

Features

- ♦ Dropout voltage typically 0.6V @lo=1A
- Output current up to 1A
- ♦ Output voltage trimmed before assembly

Absolute Maximum Rating (Note 1)

- ♦ +60V Transient peak voltage
- Internal current limit
- ♦ Thermal shutdown protection



Ordering Information

Part No.	Operation Temp.	Package
TS2940CZ <u>xx</u>	-40 ~ +125 °C	TO-220
TS2940CM <u>xx</u>		TO-263
TS2940CP <u>xx</u>	-40 ~ +85 °C	TO-252
TS2940CW <u>xx</u>		SOT-223

Note: Where <u>xx</u> denotes voltage option, available are 5.0V, 3.3V, 2.5V and 1.8V. Contact factory for additional voltage options.

Input Supply Voltage (Note 2)	Vin	-18 ~ +60	V
Operation Input Supply Voltage	Vin (operate)	30V	V
Power Dissipation (Note 3)	P _D	Internally Limited	W
Operating Junction Temperature Range	TJ	-40 ~ +125	°C
Storage Temperature Range	T _{STG}	-65 ~ +150	°C
Lead Soldering Temperature (260 °C)			
TO-220 TO-263 Package		5	S
TO-252 / SOT-223Package		4	



Electrical Characteristics Vin = Vout + 5V, $I_L = 5mA$, $C_o = 10uF$, Ta = 25 °C, unless otherwise specified.					
Output Voltage		0.980 Vo	5.0 / 3.3	1.020 Vo	V
Output Voltage	$5mA \le I_L \le 1A$, Vo+5V $\le Vin \le 26V$	0.970 Vo	2.5 / 1.8	1.030 Vo	V
Input Supply Voltage				26	V
Output Voltage Temperature Coefficient			50	150	ppm/ °C
Line Regulation	Vo+2V \leq Vin \leq 26V		0.05	0.5	%
Load Regulation	$5mA \le I_L \le 1A$		0.2	1.0	%
Dropout Voltage (Note 4)	I _L =100mA		100	200	
	I _L =500mA		300	500	mV
	I _L =800mA		600	800	
Quiescent Current (Note 5)	I∟=5mA		10		mA
	I _L =800mA		30		
Short Circuit Current (Note 6)	Vout=0			1.5	А
Output Noise,	C _L =2.2uF		500		
10Hz to 100KHz, I _L =10mA	C _L =3.3uF		350		uVrms
	C _L =33uF		120		

Thermal Performance			
Condition	Package type	Тур	Unit
Thermal Resistance	TO-220	60	
Junction to Ambient	TO-263	80	°C/W
	TO-252	150	
	SOT-223	170	

Note 1: Absolute Maximum Rating is limits beyond which damage to the device may occur. For guaranteed specifications and test conditions see the Electrical Characteristics.

Note 2: Maximum positive supply voltage of 60V must be limited duration (<100mS) and duty cycle (<1%).

Note 3: The maximum allowable power dissipation is a function of the maximum junction temperature, Tj, the junction to ambient thermal resistance, θja, and the ambient temperature, Ta. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. The effective value of θja can be reduced by using a heatsink.

Note 4: Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.

Note 5: Ground pin current is the regulator quiescent current. The total current drawn from the source is the sum of the ground pin current and output load current.

Note 6: Output current will decrease with increasing temperature, but it will be not dropped below 1A at the maximum specified temperature.

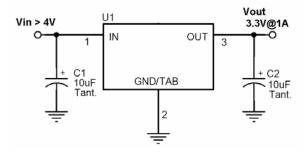


Application Information

The TS2940 series is a high performance with low dropout voltage regulator suitable for moderate to high current and voltage regulator application. Its 600mA(typ) dropout voltage at full load and over temperature makes it especially valuable in battery power systems and as high efficiency noise filters in post regulator applications. Unlike normal NPN transistor design, where the base to emitter voltage drop and collector to emitter saturation voltage limit the minimum dropout voltage, dropout performance of the PNP output of these devices is limited only by low Vce saturation voltage.

The TS2940 series is fully protected from damage due to fault conditions. Linear current limiting is provided. Output current during overload conditions is constant. Thermal shutdown the device when the die temperature exceeds the maximum safe operating temperature. Transient protection allows device survival even when the input voltage spikes above and below nominal. The output structure of these regulators allows voltages in excess of the desired output voltage to be applied without reverse current flow.

Typical Application Circuit



Output Capacitor

The TS2940 series requires an output capacitor to maintain stability and improve transient response. Proper capacitor selection is important to ensure proper operation. The output capacitor selection is dependent upon the ESR of the output capacitor the maintain stability. When the output capacitor is 10uF or greater, the output capacitor should have an ESR less than 2 ohm. This will improve transient response as well as promoted stability. Ultra low ESR capacitors (<100mohm), such as ceramic chip capacitors may promote instability. These very low ESR levels may cause an oscillation and/or under damped transient response.

A low ESR solid tantalum capacitor works extremely well and provides good transient response and stability over temperature. Aluminum electrolytic can also be used, as long as the ESR of the capacitor is <20hm. The value of the output capacitor can be increased without limit. Higher capacitance values help to improved transient response and ripple rejection and reduce output noise.

Minimum Load Current

The TS2940 series is specified between finite loads. If the output current is too small leakage currents dominate and the output voltage rises. A 10mA minimum load current is necessary for proper regulation.

Input Capacitor

An input capacitor of 1uF or greater is recommended when the device is more that 4 inches away from the bulk AC supply capacitance or when the supply is a battery. Small and surface mount ceramic chip capacitors can be used for bypassing. Larger values will help to improve ripple rejection by bypassing the input to the regulator, further improving the integrity of the output voltage.

Thermal Characteristics

A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible operating conditions, the junction temperature must be within the range specified under absolute maximum ratings. To determine if the heatsink is required, the power dissipated by the regulator, P_D must be calculated.

The below formula shows the voltages and currents for calculating the P_D in the regulator:

$$in = I_L / I_G$$

 $P_D = (Vin-Vout) * I_L + (Vin) * I_G$

Ex. P_D = (3.3V-2.5V) * 1A + 3.3V * 11mA

= 800mW + 36mW

= 836mW

Remark: ${\rm I}_{\rm L}$ is output load current,

- I_G is ground current. Vin is input voltage
- Vout is output voltage

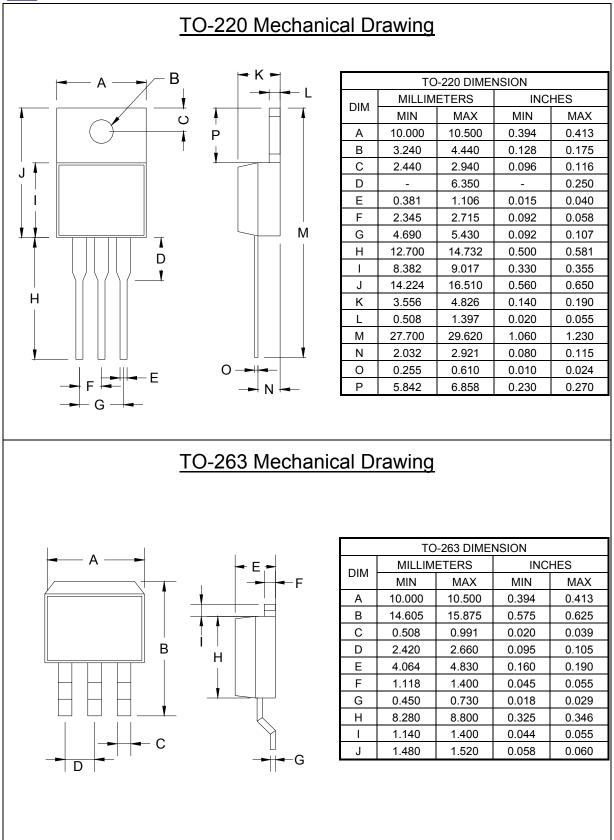
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Application Information (continued)				
The next parameter which must be calculated is the maximum allowable temperature rise, $T_R(max)$. this is calculated by the using to formula: $T_R(max) = T_J(max) - T_A(max)$ Where: $T_J(max)$ is the maximum allowable junction temperature, which is 125 °C for commercial grade parts. $T_A(max)$ is the maximum ambient temperature which will be encountered in the application. Using the calculated values for $T_R(max)$ and P_D , the maximum allowable value for the junction to ambient thermal resistance, θ_{ja} , can now be found: $\theta_{ja} = T_R(max) / P_D$	IMPORTANT: if the maximum allowable value for is found to be $\geq 60 ^{\circ}$ C/W for the TO-220 package, $\geq 80 ^{\circ}$ C/W for the TO-263 package, $\geq 150 ^{\circ}$ C/W for the TO-252 package, or $\geq 170 ^{\circ}$ C/W for the SOT-223 package, no heatsink is needed since the package alone will dissipate enough heat to satisfy these requirements. If the calculated value for θ ja falls below these limits, a heatsink is required.			

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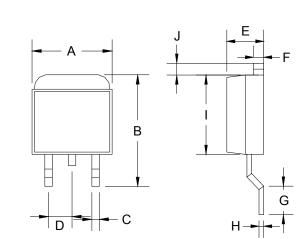




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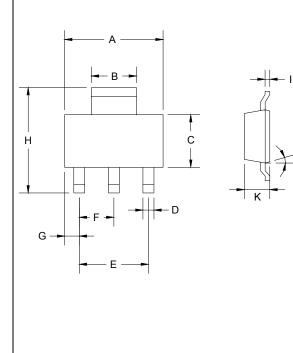


TO-252 Mechanical Drawing



TO-252 DIMENSION					
DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
А	6.570	6.840	0.259	0.269	
В	9.250	10.400	0.364	0.409	
С	0.550	0.700	0.022	0.028	
D	2.560	2.670	0.101	0.105	
Е	2.300	2.390	0.090	0.094	
F	0.490	0.570	0.019	0.022	
G	1.460	1.580	0.057	0.062	
Н	0.520	0.570	0.020	0.022	
	5.340	5.550	0.210	0.219	
J	1.460	1.640	0.057	0.065	

SOT-223 Mechanical Drawing



SOT-223 DIMENSION					
DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
А	6.350	6.850	0.250	0.270	
В	2.900	3.100	0.114	0.122	
С	3.450	3.750	0.136	0.148	
D	0.595	0.635	0.023	0.025	
Е	4.550	4.650	0.179	0.183	
F	2.250	2.350	0.088	0.093	
G	0.835	1.035	0.032	0.041	
Н	6.700	7.300	0.263	0.287	
Ι	0.250	0.355	0.010	0.014	
J	10°	16°	10°	16°	
К	1.550	1.800	0.061	0.071	

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